



ST180C..C SERIES

PHASE CONTROL THYRISTORS

Hockey Puk Version

Features

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)

350A

Typical Applications

- DC motor controls
- Controlled DC power supplies
- AC controllers



case style TO-200AB (A-PUK)

Major Ratings and Characteristics

| Parameters | ST180C..C | Units |
|-------------------|-------------|-------------------|
| $I_{T(AV)}$ | 350 | A |
| @ T_{hs} | 55 | °C |
| $I_{T(RMS)}$ | 660 | A |
| @ T_{hs} | 25 | °C |
| I_{TSM} | 5000 | A |
| @ 50Hz | 5230 | A |
| I^2t | 125 | KA ² s |
| @ 60Hz | 114 | KA ² s |
| V_{DRM}/V_{RRM} | 400 to 2000 | V |
| t_q typical | 100 | μs |
| T_J | - 40 to 125 | °C |

ELECTRICAL SPECIFICATIONS

Voltage Ratings

| Type number | Voltage Code | V_{DRM}/V_{RRM} , max. repetitive peak and off-state voltage V | V_{RSM} , maximum non-repetitive peak voltage V | I_{DRM}/I_{RRM} max. @ $T_J = T_J$ max mA |
|-------------|--------------|--|---|---|
| ST180C..C | 04 | 400 | 500 | 30 |
| | 08 | 800 | 900 | |
| | 12 | 1200 | 1300 | |
| | 16 | 1600 | 1700 | |
| | 18 | 1800 | 1900 | |
| | 20 | 2000 | 2100 | |

On-state Conduction

| Parameter | ST180C..C | Units | Conditions |
|---|---------------------------------|--------------------|--|
| $I_{T(AV)}$ @ Heatsink temperature | 350 (140) | A | 180° conduction, half sine wave double side (single side) cooled |
| | 55 (85) | °C | |
| $I_{T(RMS)}$ | 660 | A | @ 25°C heatsink temperature double side cooled |
| I_{TSM} Max. peak, one-cycle non-repetitive surge current | 5000 | | $t = 10\text{ms}$ |
| | 5230 | | $t = 8.3\text{ms}$ |
| | 4200 | | $t = 10\text{ms}$ |
| | 4400 | | $t = 8.3\text{ms}$ |
| I^2t Maximum I^2t for fusing | 125 | KA ² s | No voltage reapplied |
| | 114 | | |
| | 88 | | |
| | 81 | | |
| $I^2\sqrt{t}$ | 1250 | KA ² /s | $t = 0.1$ to 10ms , no voltage reapplied |
| $V_{T(TO)1}$ Low level value of threshold voltage | 1.08 | V | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J$ max. |
| $V_{T(TO)2}$ High level value of threshold voltage | 1.14 | | $(I > \pi \times I_{T(AV)})$, $T_J = T_J$ max. |
| r_{t1} Low level value of on-state slope resistance | 1.18 | mΩ | $(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$, $T_J = T_J$ max. |
| r_{t2} High level value of on-state slope resistance | 1.14 | | $(I > \pi \times I_{T(AV)})$, $T_J = T_J$ max. |
| V_{TM} | Max. on-state voltage | V | $I_{pk} = 750\text{A}$, $T_J = T_J$ max, $t_p = 10\text{ms}$ sine pulse |
| I_H | Maximum holding current | 600 | $T_J = T_J$ max, anode supply 12V resistive load |
| I_L | Max. (typical) latching current | 1000 (300) | |

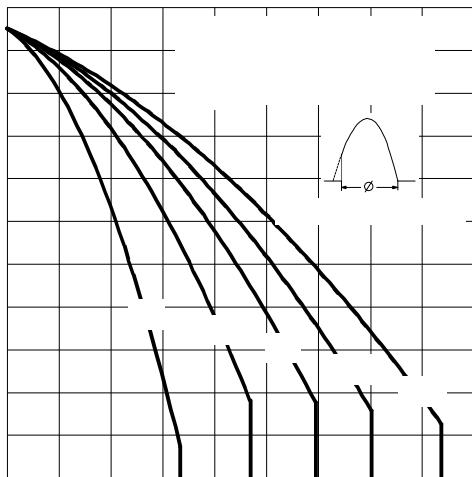


Fig. 3 - Current Ratings Characteristics

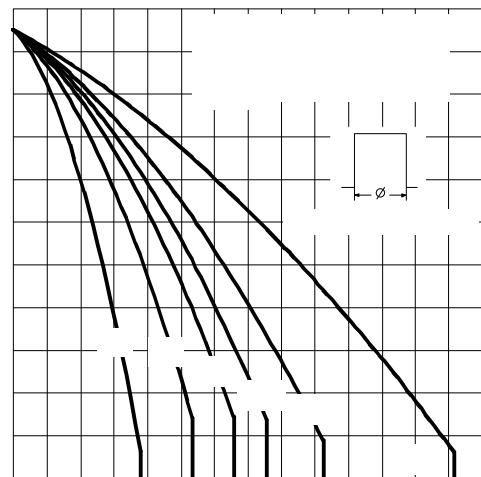


Fig. 4 - Current Ratings Characteristics

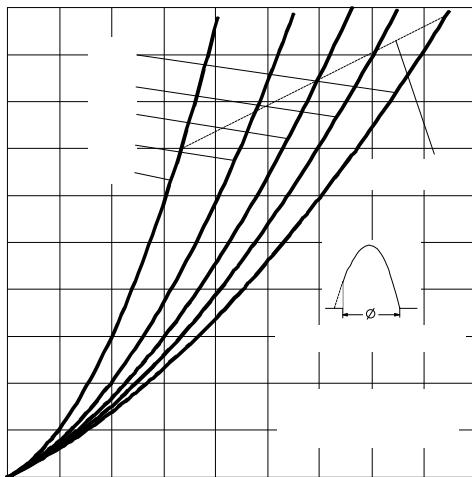


Fig. 5- On-state Power Loss Characteristics

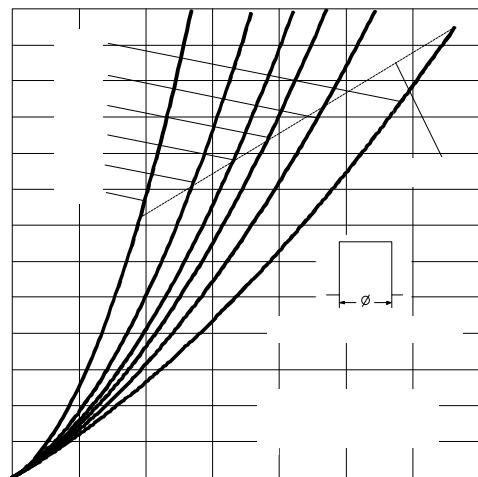


Fig. 6- On-state Power Loss Characteristics

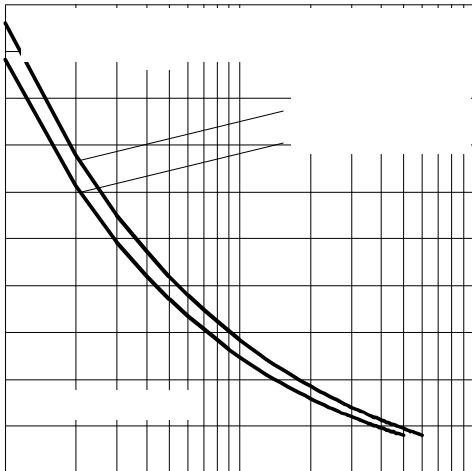


Fig. 7 - Maximum Non-Repetitive Surge Current

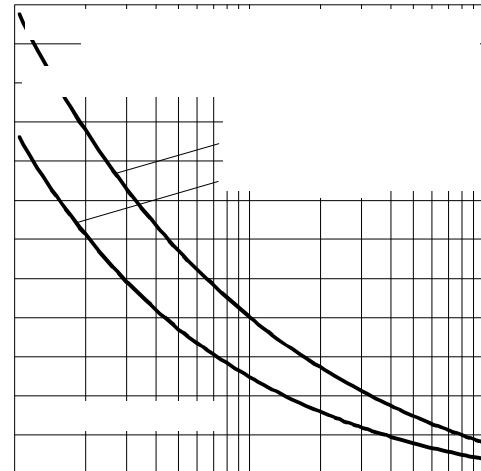


Fig. 8 - Maximum Non-Repetitive Surge Current



Fig. 9 - On-state Voltage Drop Characteristics

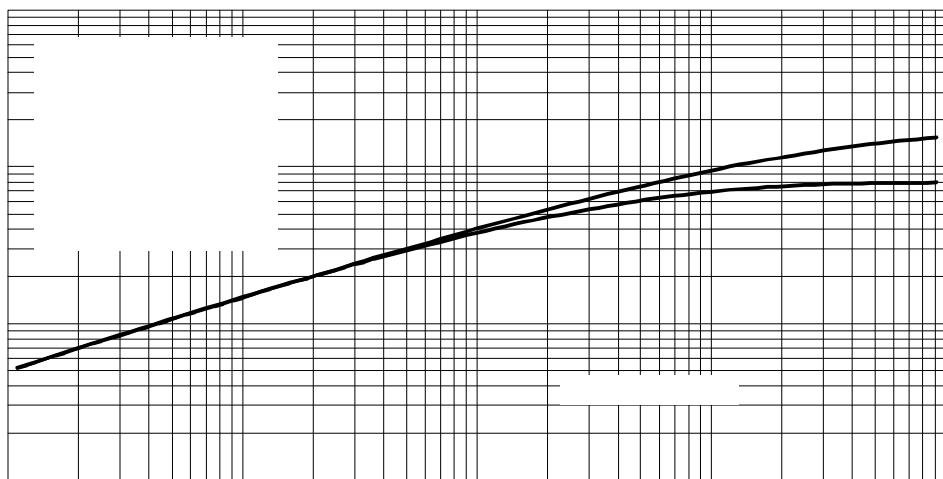
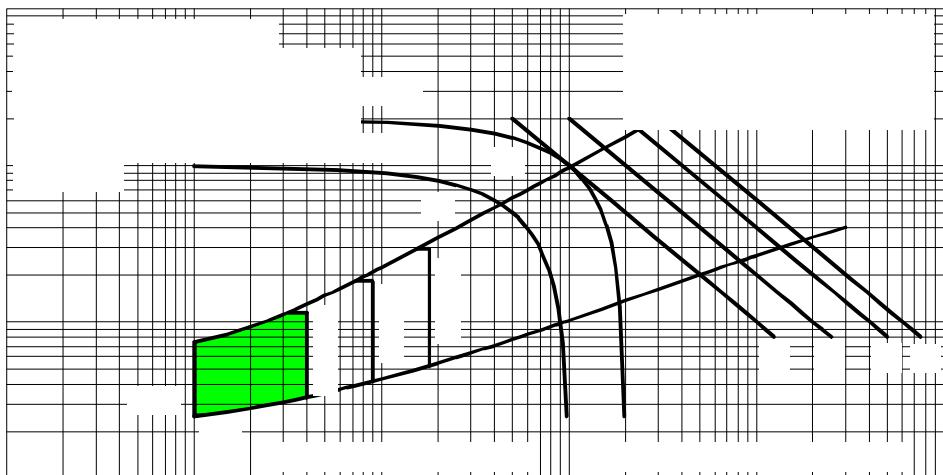
Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

Fig. 11 - Gate Characteristics

Switching

| Parameter | ST180C..C | Units | Conditions |
|---|-----------|-------|---|
| di/dt Max. non-repetitive rate of rise of turned-on current | 1000 | A/μs | Gate drive 20V, 20Ω, $t_r \leq 1\mu s$ $T_J = T_{J\max}$, anode voltage ≤ 80% V_{DRM} |
| t_d Typical delay time | 1.0 | μs | Gate current 1A, $di_g/dt = 1A/\mu s$ $V_d = 0.67\% V_{DRM}$, $T_J = 25^\circ C$ |
| t_q Typical turn-off time | 100 | | $I_{TM} = 300A$, $T_J = T_{J\max}$, $di/dt = 20A/\mu s$, $V_R = 50V$ $dv/dt = 20V/\mu s$, Gate 0V 100Ω, $t_p = 500\mu s$ |

Blocking

| Parameter | ST180C..C | Units | Conditions |
|--|-----------|-------|---|
| dv/dt Maximum critical rate of rise of off-state voltage | 500 | V/μs | $T_J = T_{J\max}$ linear to 80% rated V_{DRM} |
| I_{DRM} I_{RRM} Max. peak reverse and off-state leakage current | 30 | mA | $T_J = T_{J\max}$, rated V_{DRM}/V_{RRM} applied |

Triggering

| Parameter | ST180C..C | Units | Conditions |
|--|-----------|-------|--|
| P_{GM} Maximum peak gate power | 10 | W | $T_J = T_{J\max}$, $t_p \leq 5ms$ |
| $P_{G(AV)}$ Maximum average gate power | 2.0 | | $T_J = T_{J\max}$, $f = 50Hz$, $d\% = 50$ |
| I_{GM} Max. peak positive gate current | 3.0 | A | $T_J = T_{J\max}$, $t_p \leq 5ms$ |
| $+V_{GM}$ Maximum peak positive gate voltage | 20 | V | |
| $-V_{GM}$ Maximum peak negative gate voltage | 5.0 | | $T_J = T_{J\max}$, $t_p \leq 5ms$ |
| I_{GT} DC gate current required to trigger | TYP. | MAX. | $T_J = -40^\circ C$ $T_J = 25^\circ C$ $T_J = 125^\circ C$ Max. required gate trigger/ current/voltage are the lowest value which will trigger all units 12V anode-to-cathode applied |
| | 180 | - | |
| | 90 | 150 | |
| | 40 | - | |
| V_{GT} DC gate voltage required to trigger | 2.9 | - | $T_J = -40^\circ C$ $T_J = 25^\circ C$ $T_J = 125^\circ C$ |
| | 1.8 | 3.0 | |
| | 1.2 | - | |
| I_{GD} DC gate current not to trigger | 10 | mA | $T_J = T_{J\max}$ Max. gate current/voltage not to trigger is the max. value which will not trigger any unit with rated V_{DRM} anode-to-cathode applied |
| V_{GD} DC gate voltage not to trigger | 0.25 | V | |

ST180C..C Series

Thermal and Mechanical Specification

| Parameter | ST180C..C | Units | Conditions |
|--------------|--|--------------------|---|
| T_J | Max. operating temperature range | -40 to 125 | |
| T_{stg} | Max. storage temperature range | -40 to 150 | |
| R_{thJ-hs} | Max. thermal resistance, junction to heatsink | 0.17 0.08 | K/W DC operation single side cooled DC operation double side cooled |
| R_{thC-hs} | Max. thermal resistance, case to heatsink | 0.033 0.017 | K/W DC operation single side cooled DC operation double side cooled |
| F | Mounting force, $\pm 10\%$ | 4900 (500) | N (Kg) |
| wt | Approximate weight | 50 | g |
| | Case style | TO - 200AB (A-PUK) | See Outline Table |

$\Delta R_{th,I-hs}$ Conduction

(The following table shows the increment of thermal resistance $R_{th,Lhs}$ when devices operate at different conduction angles than DC)

| Conduction angle | Sinusoidal conduction | | Rectangular conduction | | Units | Conditions |
|------------------|-----------------------|-------------|------------------------|-------------|-------|-------------------|
| | Single Side | Double Side | Single Side | Double Side | | |
| 180° | 0.015 | 0.015 | 0.011 | 0.011 | K/W | $T_J = T_{J\max}$ |
| 120° | 0.018 | 0.019 | 0.019 | 0.019 | | |
| 90° | 0.024 | 0.024 | 0.026 | 0.026 | | |
| 60° | 0.035 | 0.035 | 0.036 | 0.037 | | |
| 30° | 0.060 | 0.060 | 0.060 | 0.061 | | |

Ordering Information Table

Device Code

| | | | | | | | |
|----|----|---|---|----|---|---|---|
| ST | 18 | 0 | C | 20 | C | 1 | |
| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |

- 1** - Thyristor
- 2** - Essential part number
- 3** - 0 = Converter grade
- 4** - C = Ceramic Puk
- 5** - Voltage code: Code x 100 = V_{RRM} (See Voltage Rating Table)
- 6** - C = Puk Case TO-200AB (A-PUK)
- 7** - 0 = Eyelet terminals (Gate and Auxiliary Cathode Unsoldered Leads)
1 = Fast-on terminals (Gate and Auxiliary Cathode Unsoldered Leads)
2 = Eyelet terminals (Gate and Auxiliary Cathode Soldered Leads)
3 = Fast-on terminals (Gate and Auxiliary Cathode Soldered Leads)
- 8** - Critical dv/dt: None = 500V/ μ sec (Standard value)
L = 1000V/ μ sec (Special selection)

Outline Table

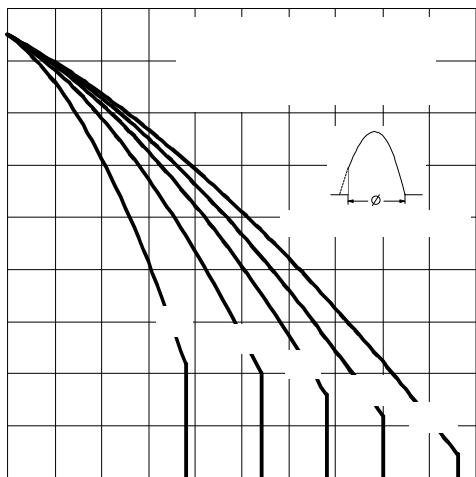
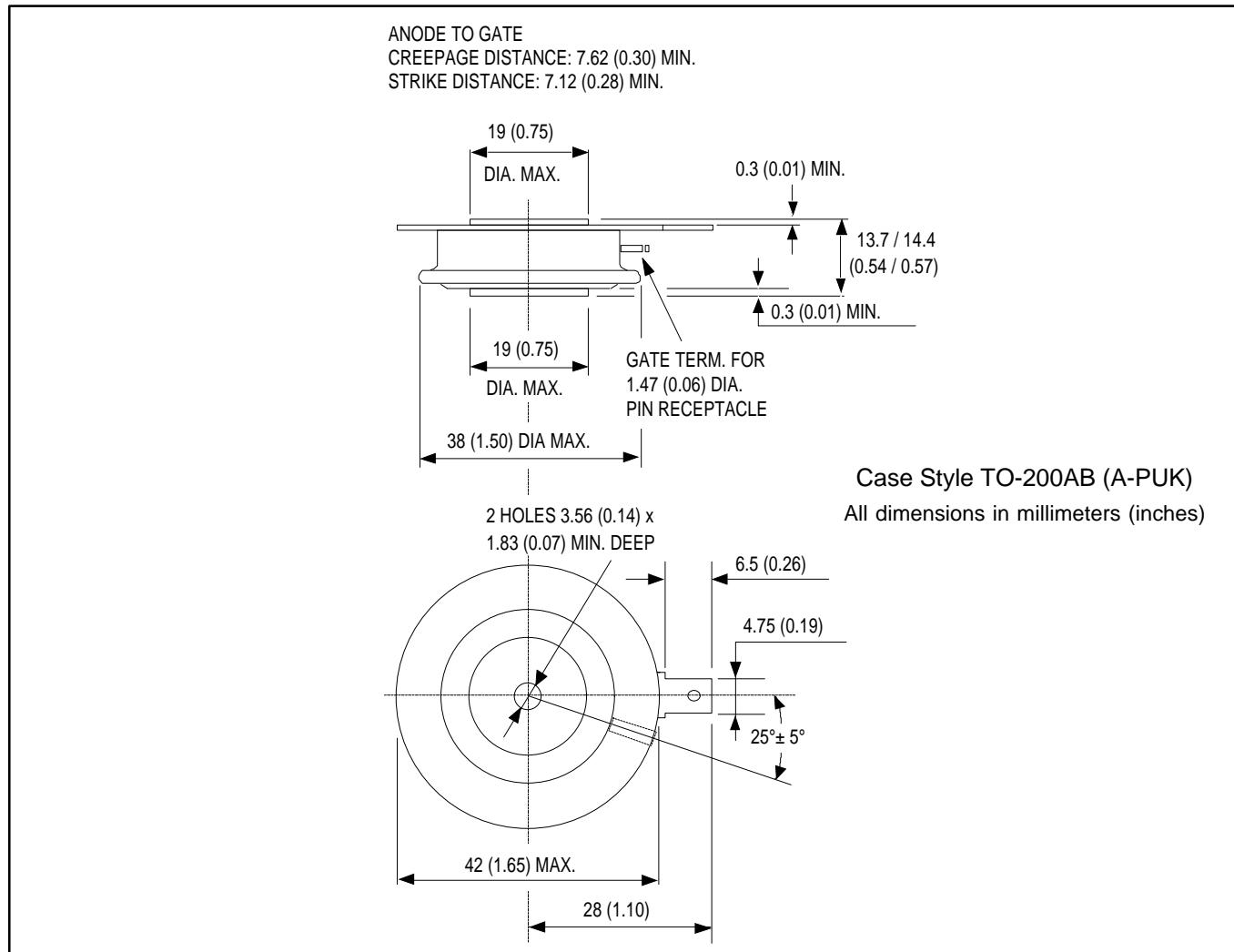


Fig. 1 - Current Ratings Characteristics

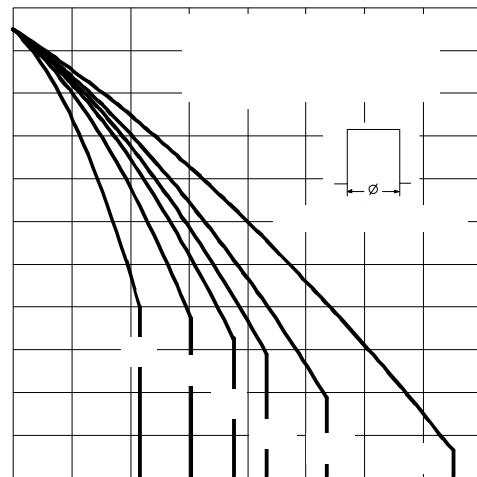


Fig. 2 - Current Ratings Characteristics